



DIP632-001BLF Information

Heisener.com

Part Number DIP632-001BLF **Manufacturer** Amphenol FCI

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 32POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









DIP632-001BLF Specifications

Manufacturer Part Number	DIP632-001BLF
Manufacturer	Amphenol FCI
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	-
Туре	DIP, 0.6" (15.24mm) Row Spacing
Number of Positions or Pins (Grid)	32 (2 x 16)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30μin (0.76μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200μin (5.08μm)
Contact Material - Post	Brass
Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester, Glass Filled
Operating Temperature	-
	Report errors?

DIP632-001BLF Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

DIP632-001BLF Payment Methods



















DIP632-001BLF Shipping Methods













If you have any question about DIP632-001BLF, please do not hesitate to contact us!

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